

- **3:21 Data Channel Expansion at up to 178.5 Mbytes/s Throughput**
- **Suited for SVGA, XGA, or SXGA Display Data Transmission From Controller to Display With Very Low EMI**
- **Three Data Channels and Clock Low-Voltage Differential Channels In and 21 Data and Clock Low-Voltage TTL Channels Out**
- **Operates From a Single 3.3-V Supply and 250 mW (Typ)**
- **5-V Tolerant $\overline{\text{SHTDN}}$ Input**
- **ESD Protection Exceeds 4 kV on Bus Pins**
- **Packaged in Thin Shrink Small-Outline Package (TSSOP) With 20-Mil Terminal Pitch**
- **Consumes Less Than 1 mW When Disabled**
- **Wide Phase-Lock Input Frequency Range 31 MHz to 68 MHz**
- **No External Components Required for PLL**
- **Open-Circuit Receiver Fail-Safe Design**
- **Inputs Meet or Exceed the Requirements of ANSI EIA/TIA-644 Standard**
- **Improved Replacement for the National™ DS90C562**

**DGG PACKAGE
(TOP VIEW)**

D17	1	48	V _{CC}
D18	2	47	D16
GND	3	46	D15
D19	4	45	D14
D20	5	44	GND
NC	6	43	D13
LVDSGND	7	42	V _{CC}
A0M	8	41	D12
A0P	9	40	D11
A1M	10	39	D10
A1P	11	38	GND
LVDSV _{CC}	12	37	D9
LVDSGND	13	36	V _{CC}
A2M	14	35	D8
A2P	15	34	D7
CLKINM	16	33	D6
CLKINP	17	32	GND
LVDSGND	18	31	D5
PLL _{GND}	19	30	D4
PLL _{V_{CC}}	20	29	D3
PLL _{GND}	21	28	V _{CC}
$\overline{\text{SHTDN}}$	22	27	D2
CLKOUT	23	26	D1
D0	24	25	GND

description

NC – Not Connected

The SN75LVDS86 FlatLink receiver contains three serial-in 7-bit parallel-out shift registers, a 7× clock synthesizer, and four low-voltage differential signaling (LVDS) line receivers in a single integrated circuit. These functions allow receipt of synchronous data from a compatible transmitter, such as the SN75LVDS81, '83, '84, or '85, over four balanced-pair conductors, and expansion to 21 bits of single-ended low-voltage TTL (LVTTTL) synchronous data at a lower transfer rate.

When receiving, the high-speed LVDS data is received and loaded into registers at seven times (7×) the LVDS input clock (CLKIN) rate. The data is then unloaded to a 21-bit-wide LVTTTL parallel bus at the CLKIN rate. A phase-locked loop (PLL) clock synthesizer circuit generates a 7× clock for internal clocking and an output clock for the expanded data. The SN75LVDS86 presents valid data on the falling edge of the output clock (CLKOUT).

The SN75LVDS86 requires only four line-termination resistors for the differential inputs and little or no control. The data bus appears the same at the input to the transmitter and output of the receiver with the data transmission transparent to the user. The only possible user intervention is the use of the shutdown/clear ($\overline{\text{SHTDN}}$) active-low input to inhibit the clock and shut off the LVDS receivers for lower power consumption. A low level on this signal clears all internal registers to a low level.



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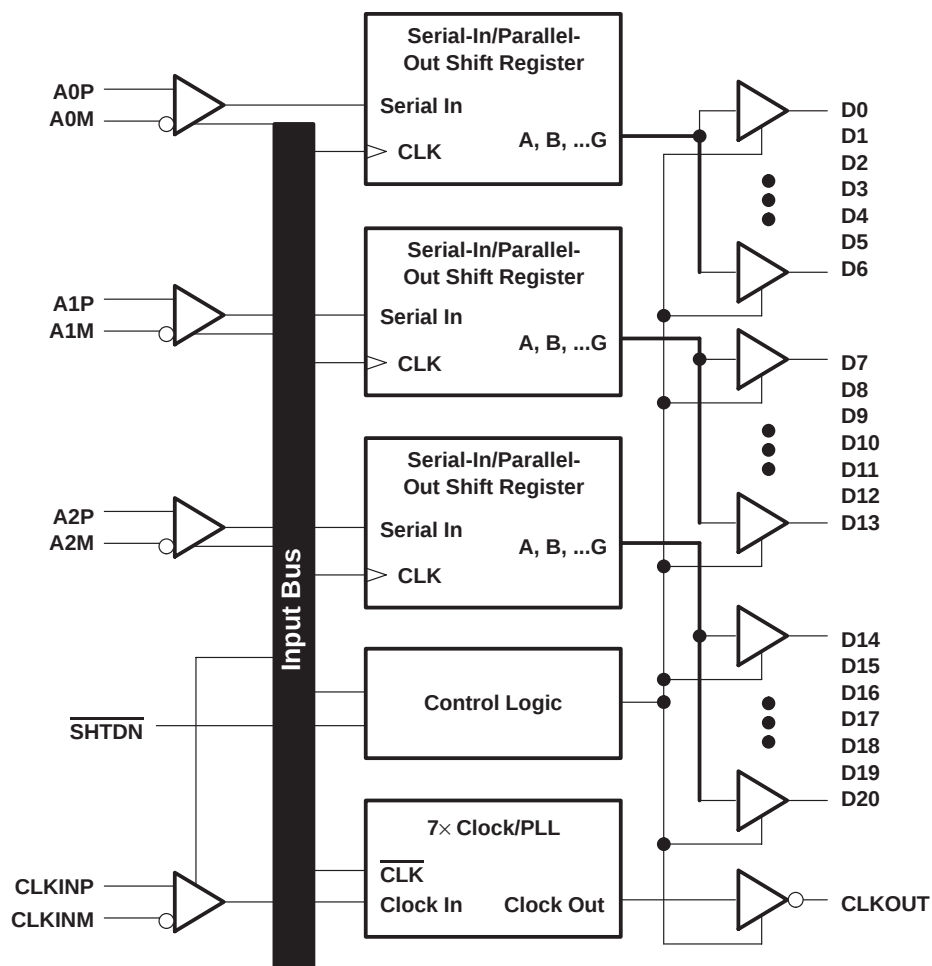
SN75LVDS86 FlatLink™ RECEIVER

SLLS268D – MARCH 1997 – REVISED JULY 2006

The LVDS receivers of the SN75LVDS86 include an open-circuit fail-safe design, such that when the inputs are not connected to an LVDS driver, the receiver outputs go to a low level. This occurs even when the line is differentially terminated at the receiver inputs.

The SN75LVDS86 is characterized for operation over ambient free-air temperatures of 0°C to 70°C.

functional block diagram



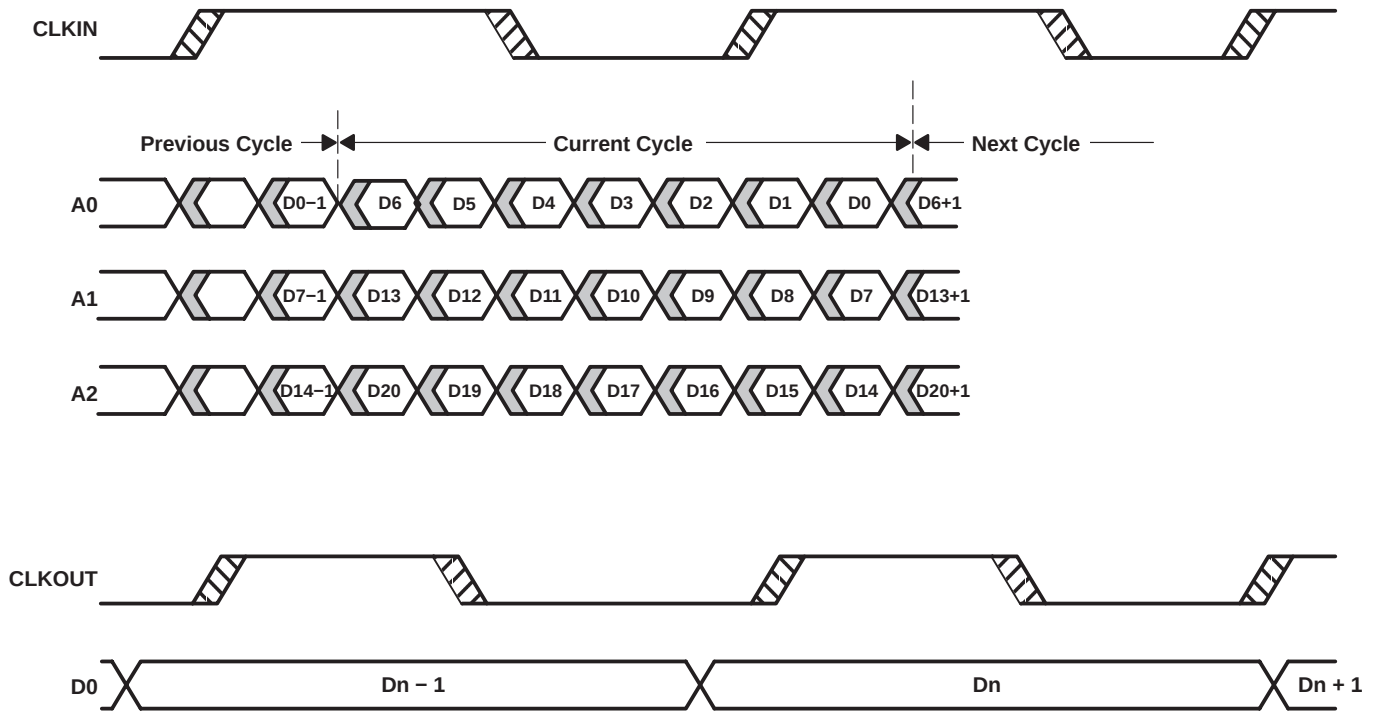
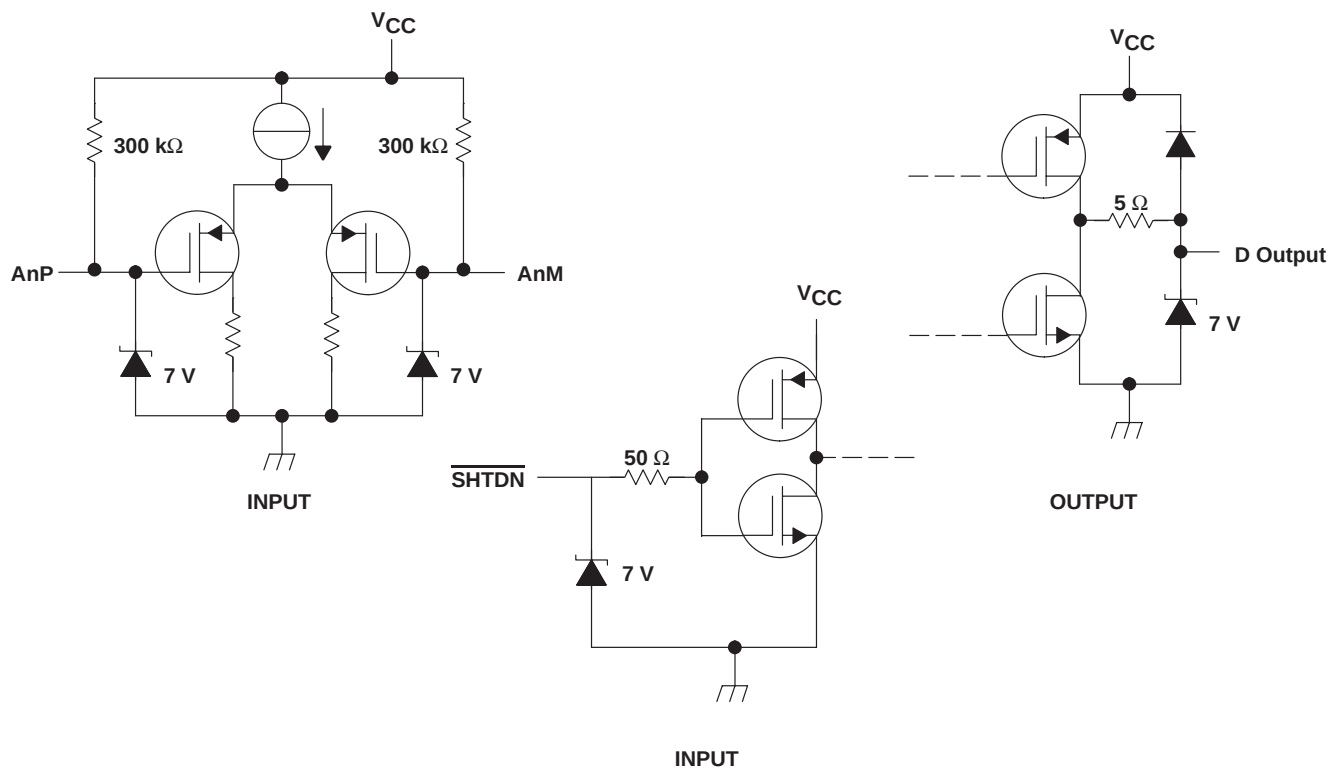


Figure 1. SN75LVDS86 Load and Shift Timing Sequences

equivalent input and output schematic diagrams



SN75LVDS86

FlatLink™ RECEIVER

SLLS268D – MARCH 1997 – REVISED JULY 2006

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC} (see Note 1)	–0.5 V to 4 V
Output voltage range, V_O (Dxx terminals)	–0.5 V to $V_{CC} + 0.5$ V
Input voltage range, V_I : Any terminal except $\overline{SHTDN}$	–0.5 V to $V_{CC} + 0.5$ V
$\overline{SHTDN}$	–0.5 V to 5.5 V
Continuous total power dissipation	See Dissipation Rating Table
Storage temperature range, T_{stg}	–65°C to 150°C
Lead temperature 1,6 mm (1/16 in) from case for 10 s	260°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values are with respect to GND, unless otherwise noted.

DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	DERATING FACTOR [‡] ABOVE $T_A = 25^\circ\text{C}$	$T_A = 70^\circ\text{C}$ POWER RATING
DGG	1316 mW	13.1 mW/°C	726 mW

[‡] This is the inverse of the junction-to-ambient thermal resistance when board mounted and with no air flow.

recommended operating conditions (see Figure 2)

	MIN	NOM	MAX	UNIT
Supply voltage, V_{CC}	3	3.3	3.6	V
High-level input voltage, V_{IH} ($\overline{SHTDN}$)	2			V
Low-level input voltage, V_{IL} ($\overline{SHTDN}$)			0.8	V
Differential input voltage, $ V_{ID} $	0.1		0.6	V
Common-mode input voltage, V_{IC} (see Figure 2 and Figure 3)	$\frac{ V_{ID} }{2}$	$2.4 - \frac{ V_{ID} }{2}$		V
		$V_{CC} - 0.8$		
Operating free-air temperature, T_A	0		70	°C

timing requirements

	MIN	NOM	MAX	UNIT
t_c Cycle time, input clock [§]	14.7	t_c	32.4	ns
t_{su1} Setup time, input (see Figure 7)	600			ps
t_{h1} Hold time, input (see Figure 7)	600			ps

[§] Parameter t_c is defined as the mean duration of a minimum of 32 000 clock cycles.



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electrical characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP†	MAX	UNIT
V _{IT+} Positive-going differential input threshold voltage				100	mV
V _{IT-} Negative-going differential input threshold voltage‡		-100			mV
V _{OH} High-level output voltage	I _{OH} = -4 mA	2.4			V
V _{OL} Low-level output voltage	I _{OL} = 4 mA			0.4	V
I _{CC} Quiescent current (average)	Disabled, All inputs open			280	μA
	Enabled, AnP = 1 V, AnM = 1.4 V, t _C = 15.38 ns		58	72	mA
	Enabled, C _L = 8 pF, Grayscale pattern (see Figure 4), t _C = 15.38 ns		69		
	Enabled, C _L = 8 pF, Worst-case pattern (see Figure 5), t _C = 15.38 ns		94		
I _{IH} High-level input current ($\overline{\text{SHTDN}}$)	V _{IH} = V _{CC}			±20	μA
I _{IL} Low-level input current ($\overline{\text{SHTDN}}$)	V _{IL} = 0 V			±20	μA
I _I Input current (LVDS input terminals A and CLKIN)	0 ≤ V _I ≤ 2.4 V			±20	μA
I _{OZ} High-impedance output current	V _O = 0 or V _{CC}			±10	μA

† All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

‡ The algebraic convention, in which the less-positive (more-negative) limit is designated minimum, is used in this data sheet for the negative-going input voltage threshold only.

switching characteristics over recommended operating conditions (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP†	MAX	UNIT
t _{su2} Set up time, D0–D20 valid to CLKOUT↓	C _L = 8 pF, See Figure 6	5			ns
t _{h2} Hold time, CLKOUT↓ to D0–D20 valid	C _L = 8 pF, See Figure 6	5			ns
t _{RSKM} Receiver input skew margin§ (see Figure 7)	t _C = 15.38 ns (±0.2%), Input clock jitter < 50 ps¶	490			ps
t _d Delay time, CLKIN↑ to CLKOUT↓ (see Figure 7)	t _C = 15.38 ns (±0.2%), C _L = 8 pF		3.7		ns
Δt _{C(0)} Cycle time, change in output clock period#	t _C = 15.38 + 0.75 sin(2π500E3t) ± 0.05 ns, See Figure 8		±80		ps
	t _C = 15.38 + 0.75 sin(2π3E6t) ± 0.05 ns, See Figure 8		±300		
t _{en} Enable time, $\overline{\text{SHTDN}}$ ↑ to Dn valid	See Figure 9		1		ms
t _{dis} Disable time, $\overline{\text{SHTDN}}$ ↓ to off state	See Figure 10		400		ns
t _t Transition time, output (10% to 90% t _r or t _f)	C _L = 8 pF		3		ns
t _w Pulse duration, output clock			0.43 t _C		ns

† All typical values are at V_{CC} = 3.3 V, T_A = 25°C.

§ The parameter t_{RSKM} is the timing margin available to the transmitter and interconnection skews and clock jitter. It is defined by $\frac{t_C}{14} - t_{su1}/t_{h1}$.

¶ |Input clock jitter| is the magnitude of the change in input clock period.

Δt_{C(0)} is the change in the output clock period from one cycle to the next cycle observed over 15 000 cycles.

PARAMETER MEASUREMENT INFORMATION

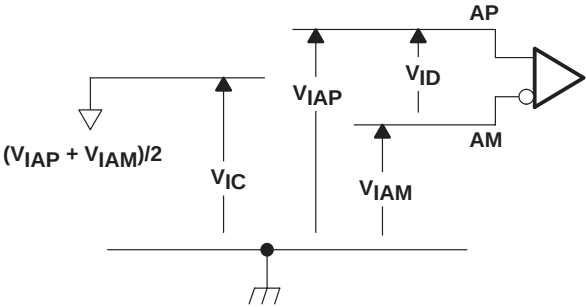


Figure 2. Voltage Definitions

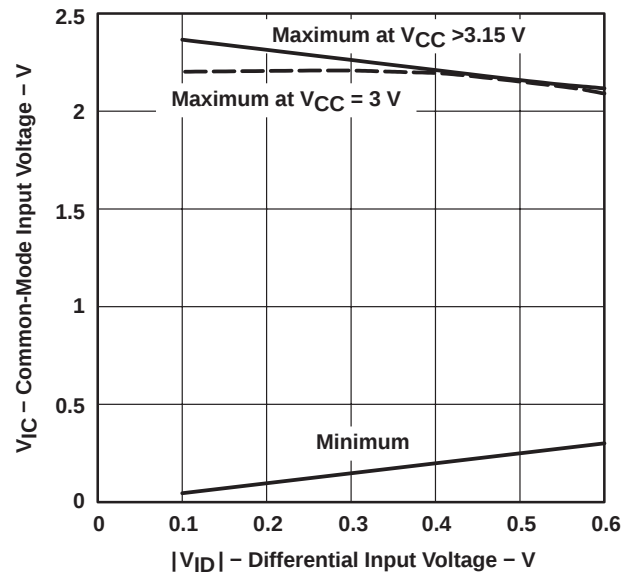
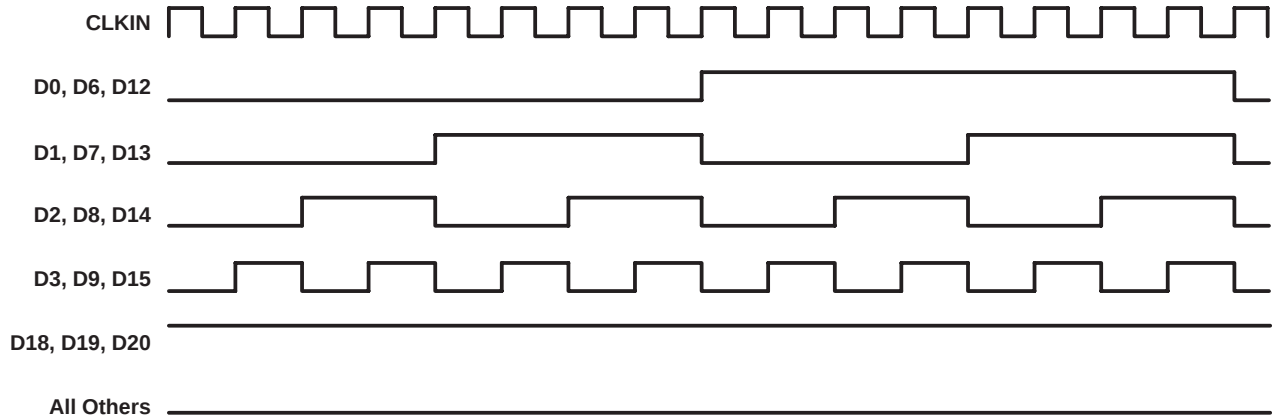


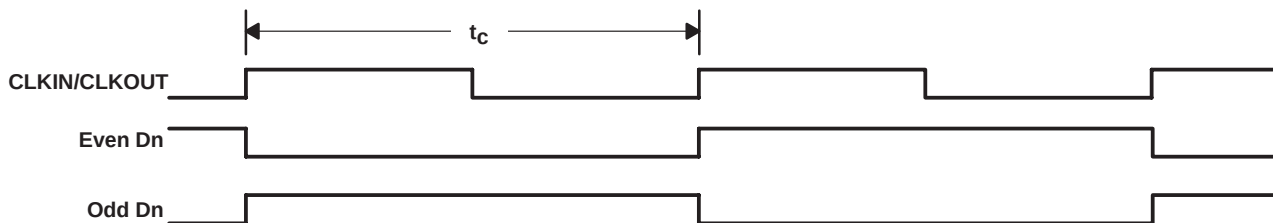
Figure 3. Common-Mode Input Voltage Vs Differential Input Voltage and V_{CC}

PARAMETER MEASUREMENT INFORMATION



NOTE A: The 16-grayscale test-pattern test device power consumption for a typical display pattern

Figure 4. 16-Grayscale Test Pattern



NOTE B: The worst-case test pattern produces nearly the maximum switching frequency for all of the LVTTTL outputs.

Figure 5. Worst-Case Test Pattern

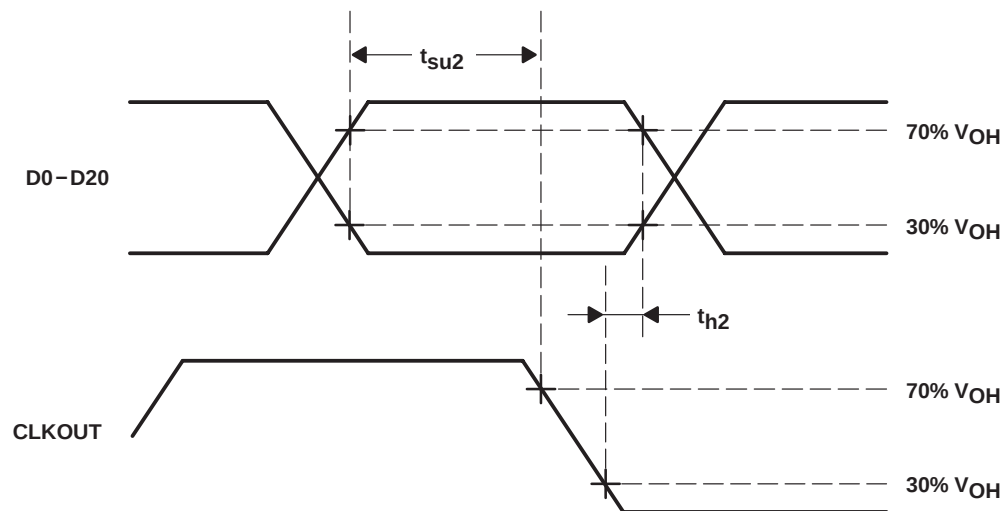
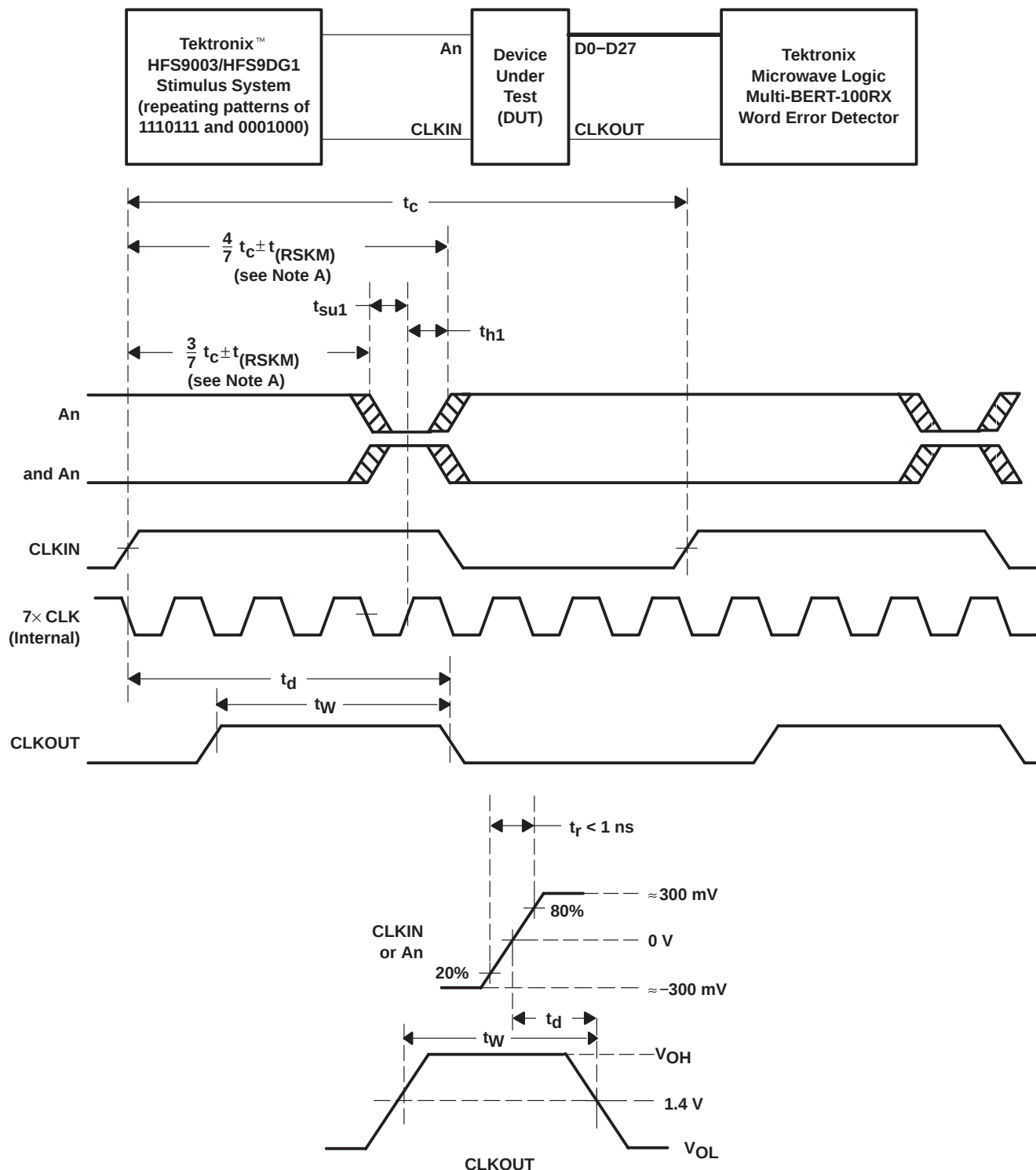


Figure 6. Setup and Hold Time

PARAMETER MEASUREMENT INFORMATION



NOTE A: CLKIN is advanced or delayed with respect to data until errors are observed at the receiver outputs. The advance or delay is then reduced until there are no data errors observed. The magnitude of the advance or delay is $t_{(RSKM)}$.

Figure 7. Receiver Input Skew Margin, Setup/Hold Time, and Delay Timing

PARAMETER MEASUREMENT INFORMATION

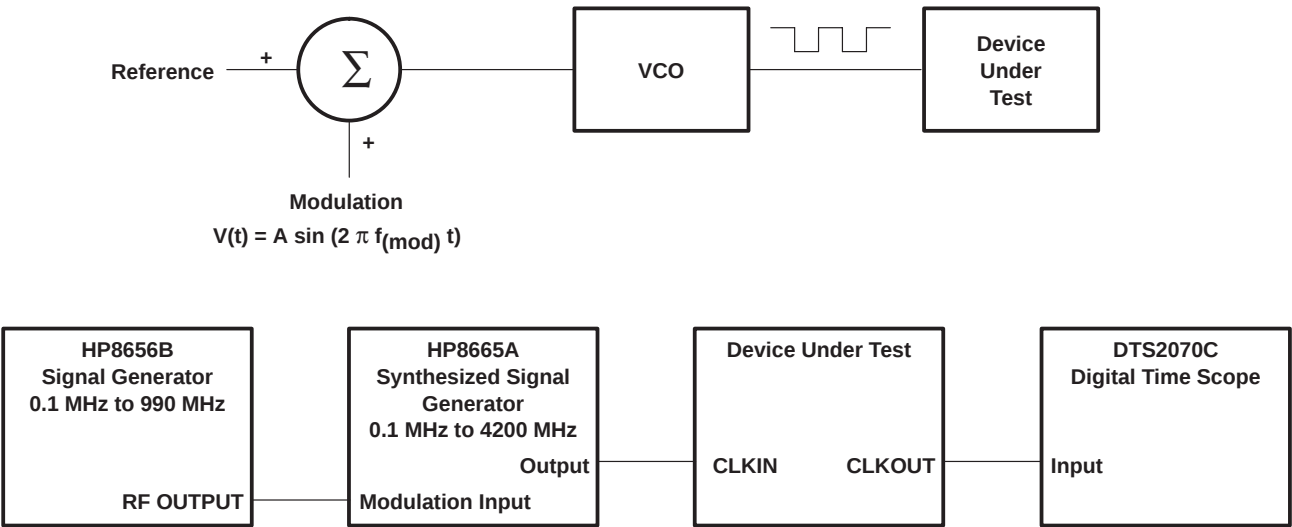


Figure 8. Output Clock Jitter Test Setup

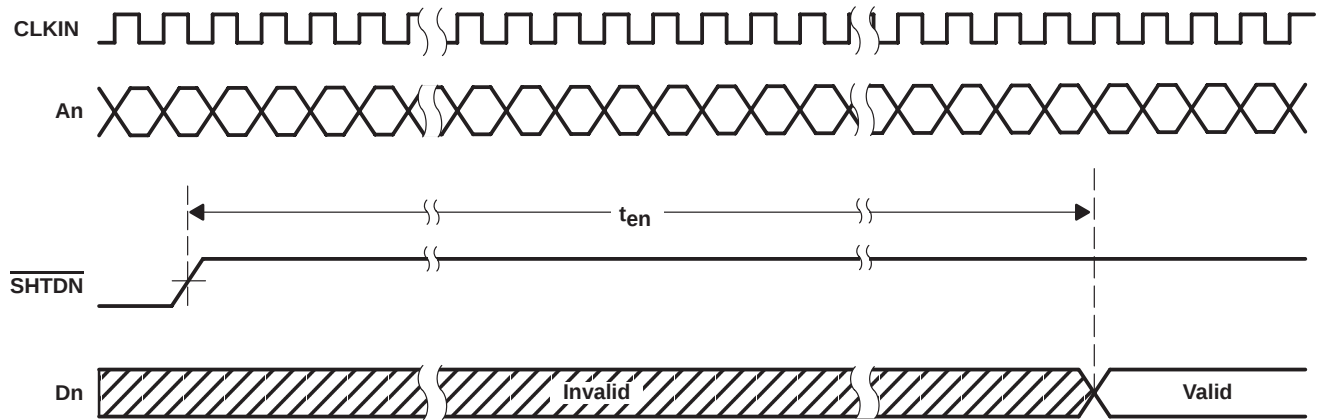


Figure 9. Enable Time

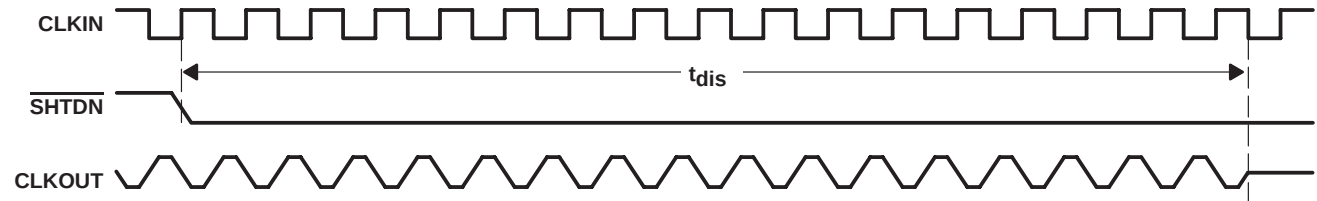


Figure 10. Disable Time

TYPICAL CHARACTERISTICS

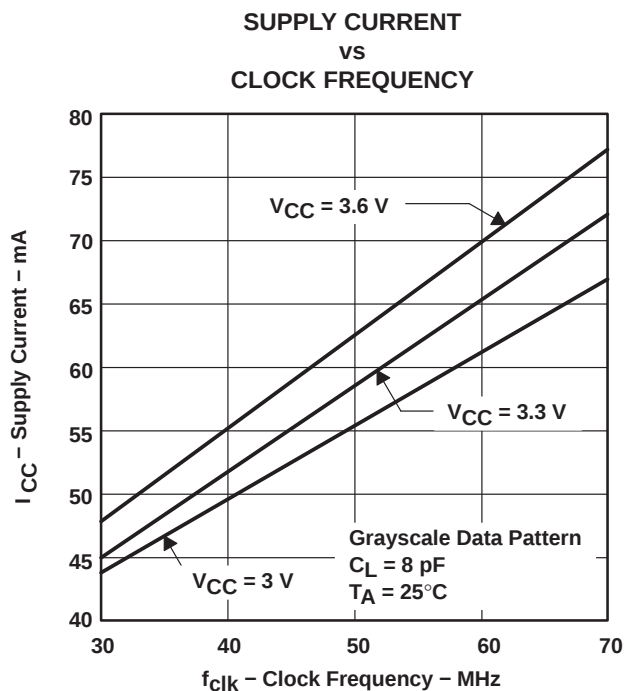


Figure 11. RMS Grayscale I_{CC} vs Clock Frequency

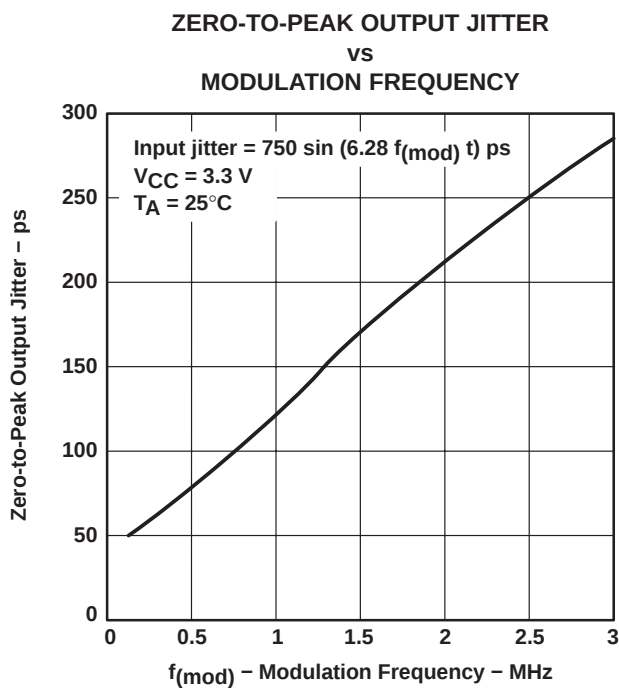
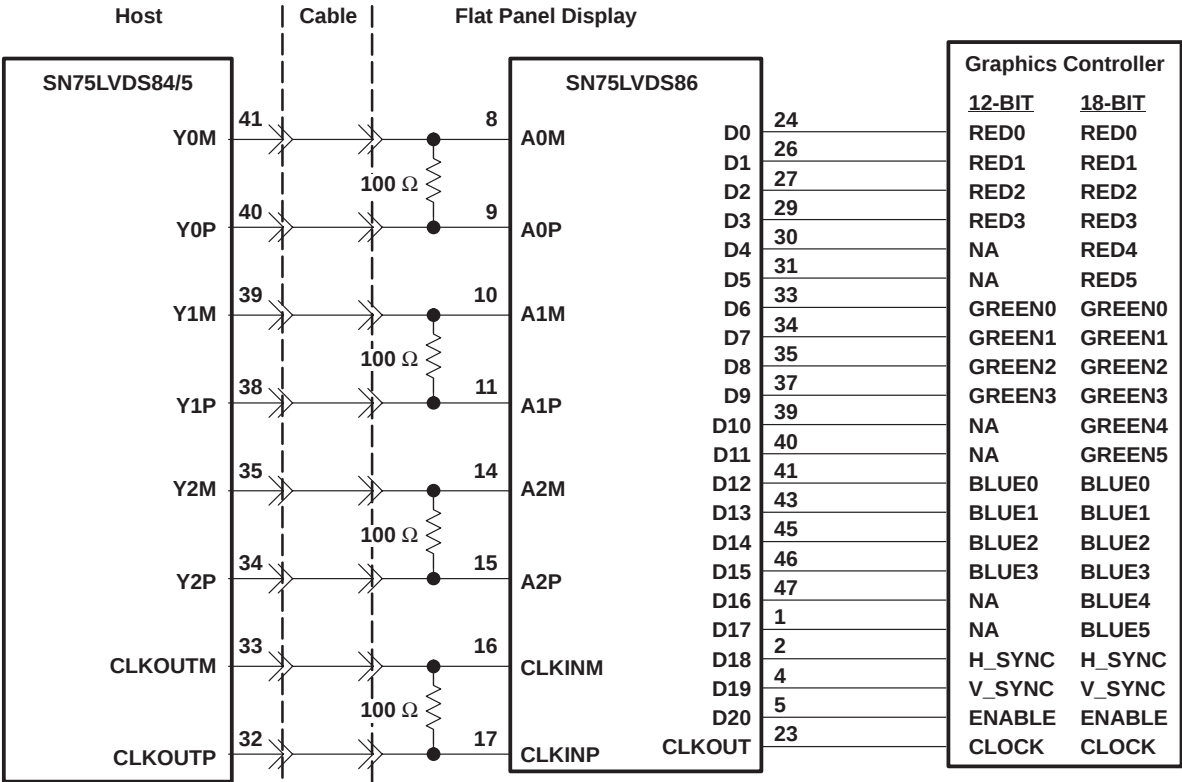


Figure 12. Typical FlatLink™ PLL Characteristics

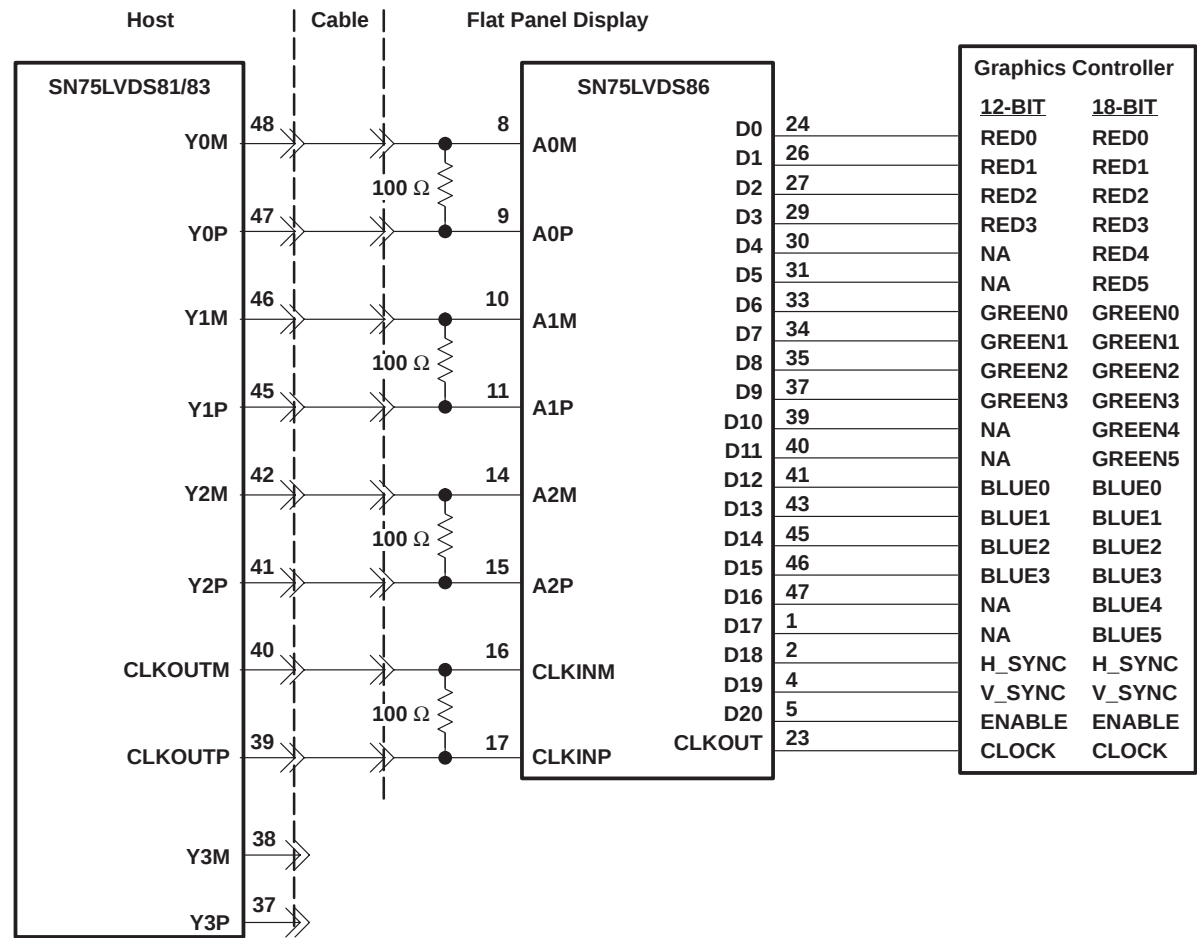
APPLICATION INFORMATION



NOTES: A. The four 100-Ω terminating resistors are recommended to be 0603 types.
B. NA – not applicable, these unused inputs should be left open.

Figure 13. 18-Bit Color Host to Flat Panel Display Application

APPLICATION INFORMATION



NOTES: A. The four 100-Ω terminating resistors are recommended to be 0603 types.
B. NA – not applicable, these unused inputs should be left open.

Figure 14. 24-Bit Color Host to 18-Bit Color LCD Panel Display Application†

† See the FlatLink™ Designer's Guide (SLLA012) for more application information.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
SN75LVDS86DGG	Active	Production	TSSOP (DGG) 48	40 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	SN75LVDS86
SN75LVDS86DGG.B	Active	Production	TSSOP (DGG) 48	40 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	SN75LVDS86

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

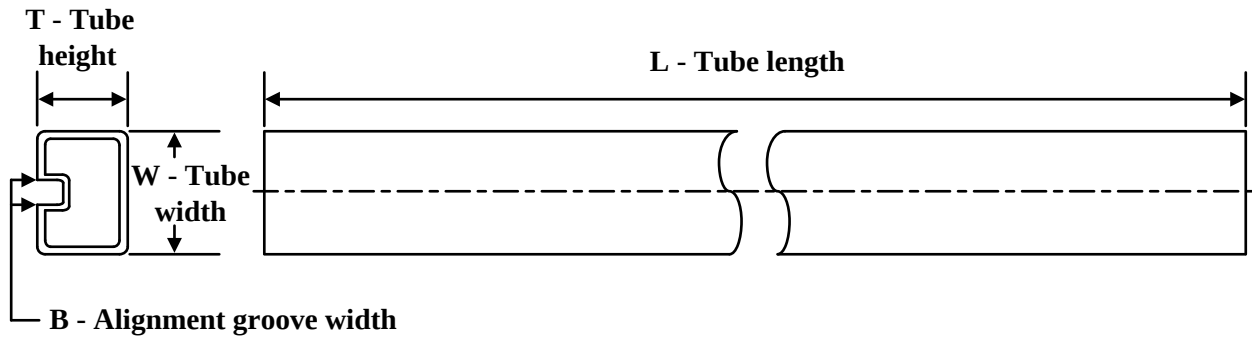
⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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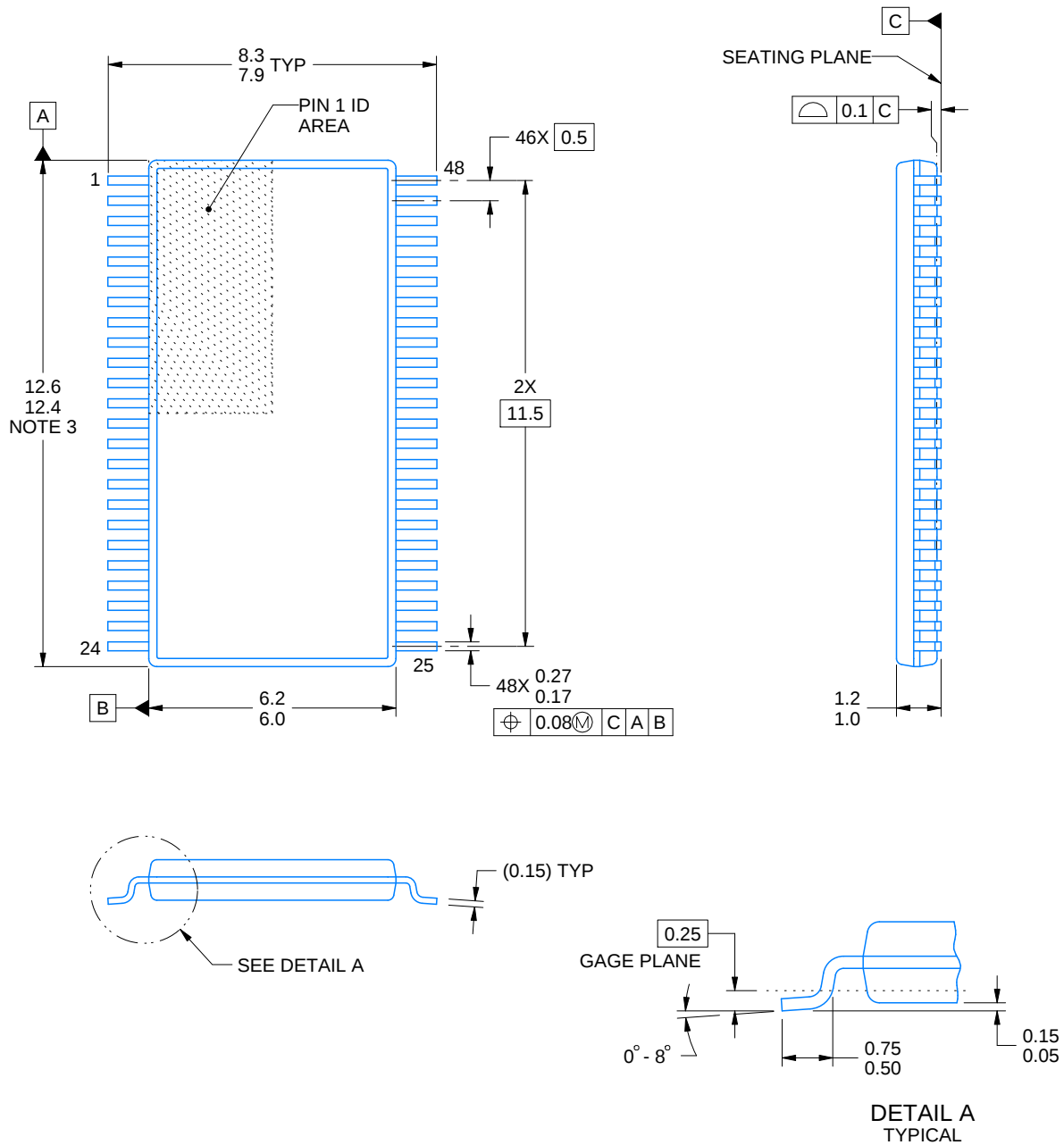
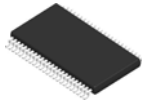
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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
SN75LVDS86DGG	DGG	TSSOP	48	40	530	11.89	3600	4.9
SN75LVDS86DGG.B	DGG	TSSOP	48	40	530	11.89	3600	4.9



4214859/B 11/2020

NOTES:

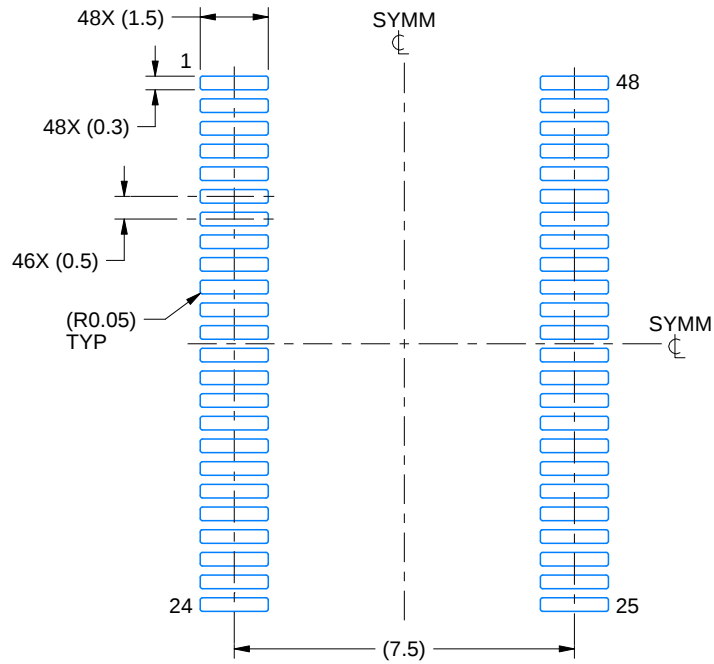
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-153.

EXAMPLE BOARD LAYOUT

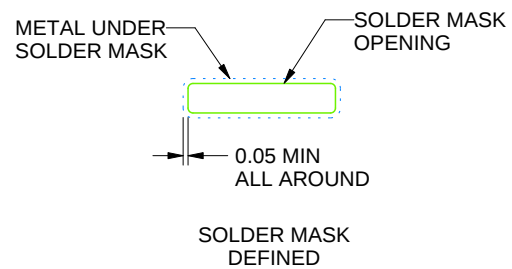
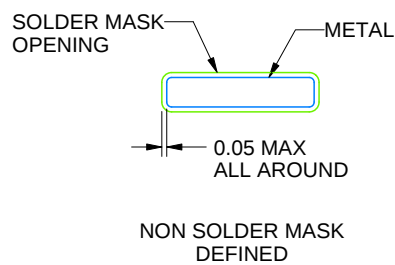
DGG0048A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
SCALE:6X



SOLDER MASK DETAILS

4214859/B 11/2020

NOTES: (continued)

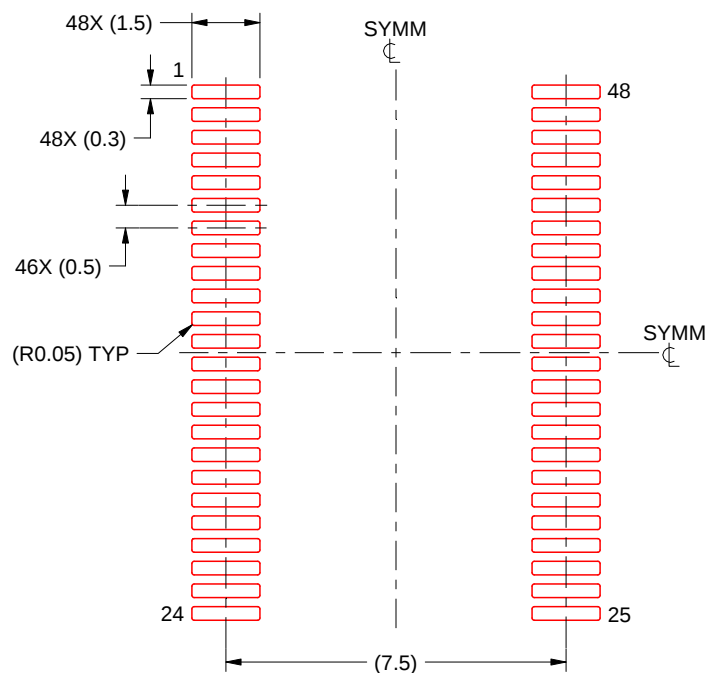
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DGG0048A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:6X

4214859/B 11/2020

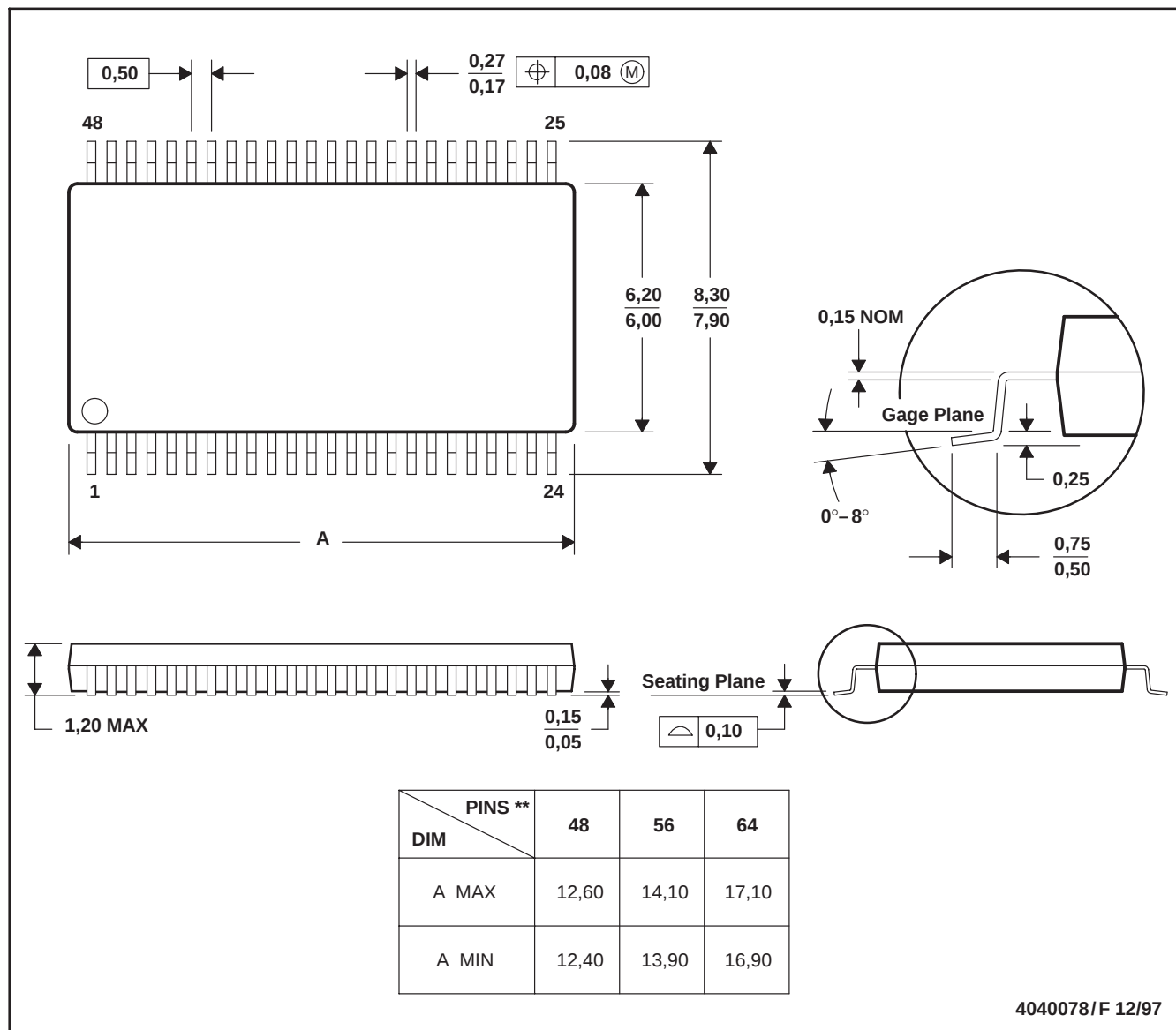
NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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